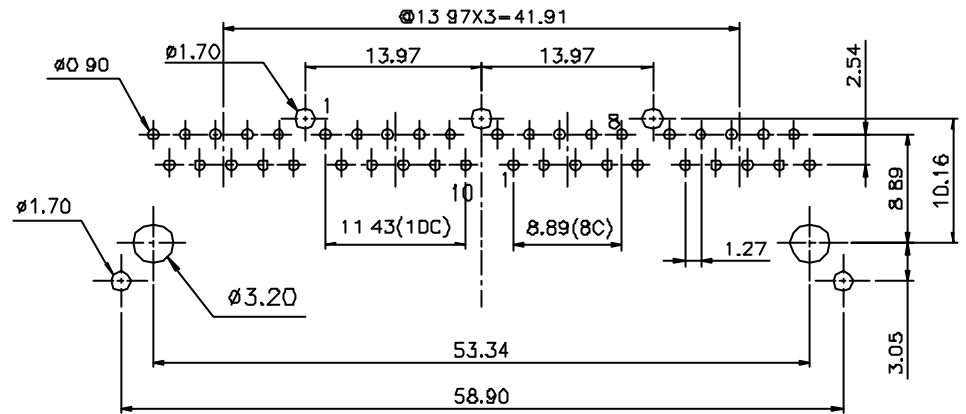
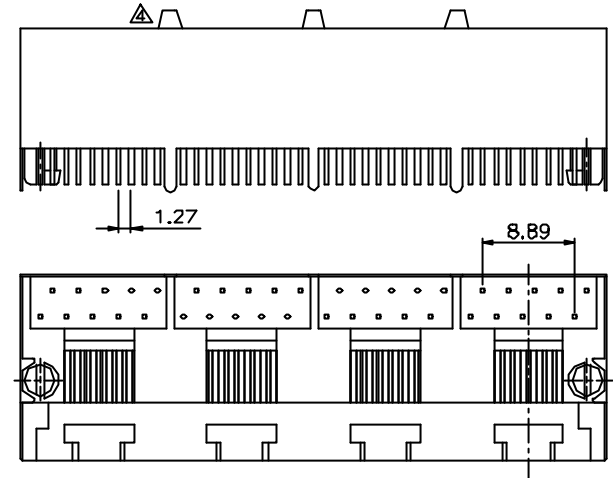
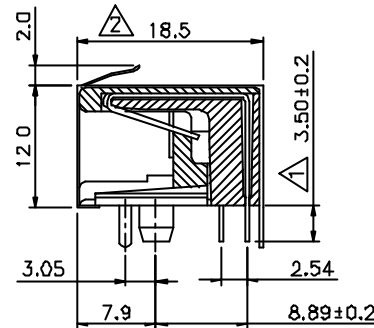
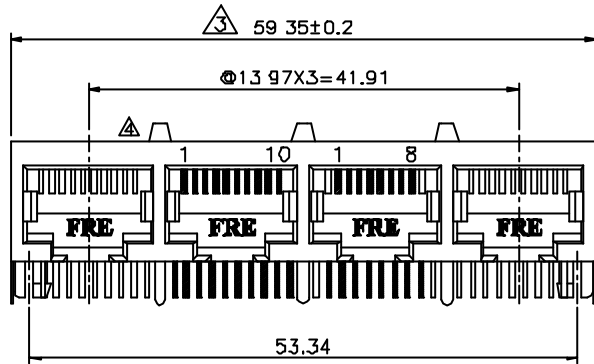


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		3.50 was 2.50	9/7/99	RACHEL
△		18.5 was 18.7	JANEY	7/31/99*
△		Modify DIM	LEN	12/03/99*
△		Modify Tabs	CHRYL	12/09/03*



PC Board Thickness=1.60mm  
PC Board Component Side Shown

**NOTES:**

**ELECTRICAL:**

- VOLTAGE RATING : 125 VAC RMS.
- CURRENT RATING : 1.5 AMP
- CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
- DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

**MECHANICAL:**

- HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- CONTACT MATERIAL : PHOSPHOR BRONZE  $\phi$ 0.46mm.
- PLATING : GOLD PLATING OVER NICKEL.
- OPERATING LIFE : 750 CYCLES MIN.
- PCB RETENTION PRE-SOLDER : 1 LB MIN.
- PCB RETENTION POST-SOLDER: 10 LBS MIN.

**ENVIRONMENTAL:**

- STORAGE : -40°C TO +85°C.
- OPERATION: -40°C TO +85°C.

MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

PART NUMBER: E560X-XXC06X

- |               |        |           |
|---------------|--------|-----------|
| B- 8 CONTACTS | 1- 3u" | 2- 6u"    |
| 1-10 CONTACTS | 3-15u" | 4-30u"    |
|               | 5-50u" | 6-Pd 20u" |

- |           |  |
|-----------|--|
| SHIELD :  | 1- FRONT PEG 3.05                        |
| D- TIN    | A- FRONT PEG 3.05, WITH 3 GROUNDING TABS |
| 4- NICKEL | B- FRONT PEG 3.05, WITH 5 GROUNDING TABS |

DETAILED LISTS	MM (INCH)	DFTO TONY DATE 5/21/97
	TOLERANCES EXCEPT AS NOTED	CHKD TZOU DATE 12/09/03*
		MFO STONE DATE 12/09/03*
		APPL YUAN DATE 12/09/03*
	ANGLES ±	QTY :
	THIRD ANGLE PROJECTION	FINISH :
		SCALE : 1.25 · 1

FULL RISE ELECTRONIC CO., LTD

TITLE		
11.5 SIDE ENTRY PCB GANG JACK 10P		
DRAWING NO. 5-0023-4	SIZE A3	REV 4
/PART NO. SEE NOTE		
DID NOT SCALE DRAWING		SHEET 1 OF 1